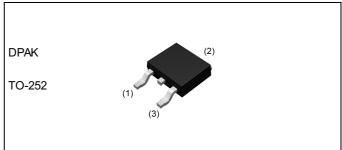


Nch 250V 4A Power MOSFET

V_{DSS}	250V
R _{DS(on)} (Max.)	1.3Ω
I _D	±4.0A
P _D	29W

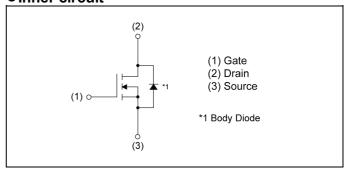
Outline



Features

- 1) Low on-resistance
- 2) Fast switching
- 3) Drive circuits can be simple
- 4) Pb-free plating; RoHS compliant
- 5) AEC-Q101 Qualified

•Inner circuit



Packaging specifications

or dekaging specifications						
Packing	Embossed Tape					
Reel size (mm)	330					
Tape width (mm)	16					
Quantity (pcs)	2500					
Taping code	TL					
Marking	RD3U041AA					
	Packing Reel size (mm) Tape width (mm) Quantity (pcs) Taping code					

Application

Switching Power Supply

● **Absolute maximum ratings** (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	250	V
Continuous drain current (T _c = 25°C)	I _D *1	±4.0	А
Pulsed drain current	I _{DP} *2	±16	А
Gate - Source voltage	V_{GSS}	±30	V
Avalanche current, single pulse	I _{AS} *3	2.0	А
Avalanche energy, single pulse	E _{AS} *3	1.61	mJ
Power dissipation (T _c = 25°C)	P _D *4	29	W
Junction temperature	T _j	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

●Thermal resistance

Dougrantou	Currele e l	Values			1.1:4
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R _{thJC} *4	-	-	4.3	°C/W
Thermal resistance, junction - ambient	R _{thJA} *5	-	-	100	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

• Electrical characteristics $(T_a = 25^{\circ}C)$

Parameter	Symbol Conditions		Values			Unit	
- Farameter	Symbol	Conditions	Min.	Тур.	Max.	UTIIL	
Drain - Source breakdown voltage	V _{(BR)DSS}	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		-	-	V	
Zero gate voltage drain current		V _{DS} = 250V, V _{GS} = 0V	-	1	10	μA	
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 30 V, V_{DS} = 0 V$	-	-	±100	nA	
Gate threshold voltage	V _{GS(th)}	V _{DS} = 10V, I _D = 1mA	3.5	-	5.5	V	
Static drain - source on - state resistance	R _{DS(on)} *6	V _{GS} = 10V, I _D = 2.0A	-	0.93	1.3	Ω	
Gate resistance	R_{G}	f = 1MHz, open drain	-	4.0	-	Ω	

● Electrical characteristics (T_a = 25°C)

Davamatar	Cymah al	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	UIIIL	
Input capacitance	C _{iss}	V _{GS} = 0V	-	350	-		
Output capacitance	C _{oss}	V _{DS} = 25V	-	30	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	15	-		
Turn - on delay time	t _{d(on)} *6	V _{DD} ≈ 125V, V _{GS} = 10V	-	15	-		
Rise time	t _r *6	I _D = 2.0A	-	14	-		
Turn - off delay time	t _{d(off)} *6	$R_L \simeq 62\Omega$	-	18	-	ns	
Fall time	t _f *6	$R_G = 10\Omega$	-	15	-		

● Gate charge characteristics (T_a = 25°C)

Darameter	Symbol Conditions		Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic
Total gate charge	Q_g^{*6}	V _{DD} ≃ 125V	-	8.5	-	
Gate - Source charge	Q _{gs} *6	I _D = 4.0A	-	3.5	-	nC
Gate - Drain charge	Q _{gd} *6	V _{GS} = 10V	-	3.5	-	
Gate plateau voltage	V _(plateau)	V _{DD} ≈ 125V, I _D = 4.0A	-	7.8	-	V

^{*1} Limited only by maximum temperature allowed.

^{*2} Pw ≤ 10µs, Duty cycle ≤ 1%

^{*3} L \simeq 500 μ H, V_{DD} = 50V, R_G = 25 Ω , starting T_i = 25°C Fig.3-1,3-2

^{*4} T_c=25°C

^{*5} Mounted on an epoxy PCB FR4 (20×20×0.8mm)

^{*6} Pulsed

● Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Offic	
Source current	I _S *1	T _C = 25°C	1	-	4.0	Α	
Pulsed source current	I _{SP} *2	1C - 23 C	1	-	16	Α	
Source-Drain voltage	V _{SD} *6	$V_{GS} = 0V, I_{S} = 4.0A$	-	-	1.5	V	
Reverse recovery time	t _{rr} *6		-	95	-	ns	
Reverse recovery charge	Q _{rr} *6	I _S = 4.0A di/dt = 100A/μs	-	0.3	-	μC	
Peak reverse recovery current	_{rr} *6		-	6.3	-	А	

Fig.1 Power Dissipation Derating Curve

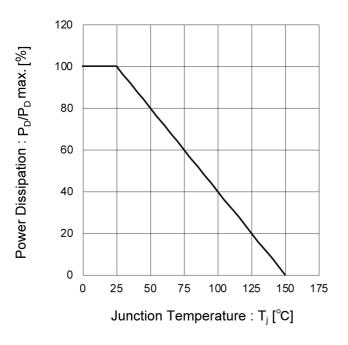


Fig.2 Drain Current Derating Curve

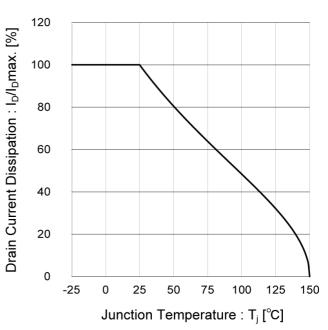


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

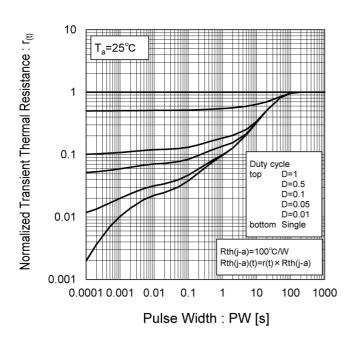
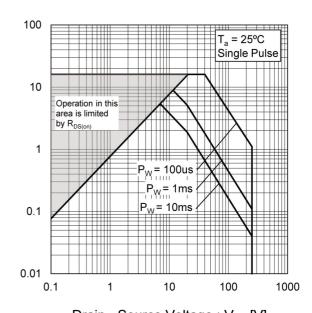


Fig.4 Maximum Safe Operating Area



Drain Current : I_D [A]

Fig.5 Avalanche Energy Derating Curve

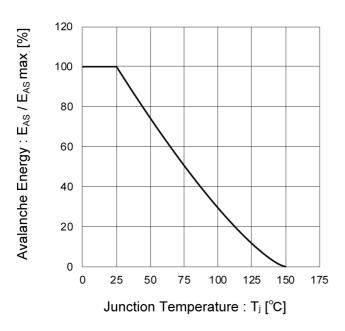


Fig.6 Normalized Breakdown Voltage vs. Junction Temperature

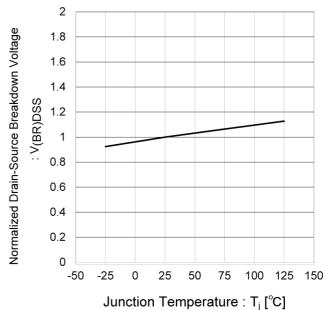


Fig.7 Output Characteristics(I)

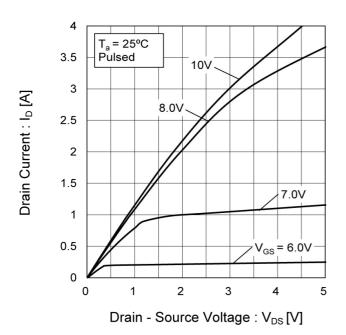
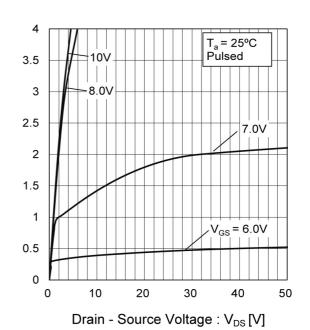


Fig.8 Output Characteristics(II)



Drain Current : I_D [A]

Fig.9 Gate Threshold Voltage vs. Drain Current

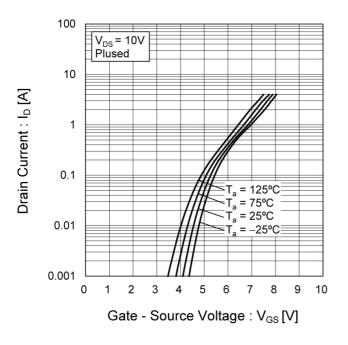


Fig.10 Normalized Gate Threshold .

Voltage vs Junction Temperature

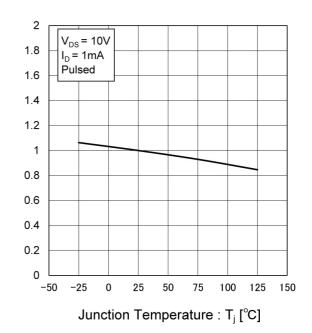


Fig.11 Static Drain - Source On - State Resistance vs. Drain Current

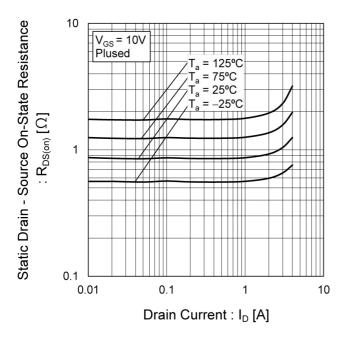
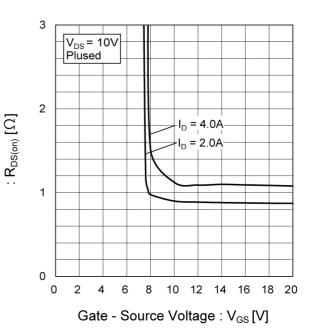


Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage



Static Drain - Source On-State Resistance

Normalized Gate Threshold Voltage : V_{GS(th)}

Fig.13 Normalized Static Drain - Source On - State Resistance vs. Junction Temperature

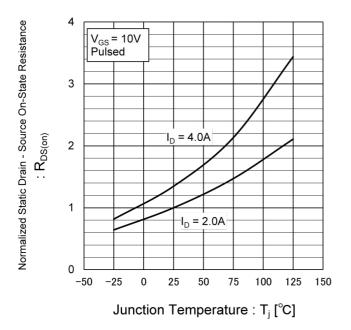


Fig.14 Capacitances

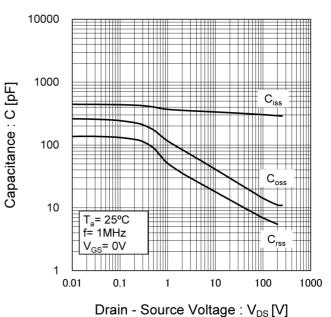


Fig.15 Switching Times

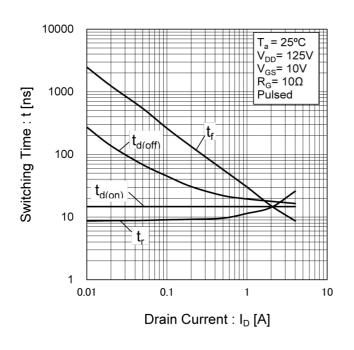
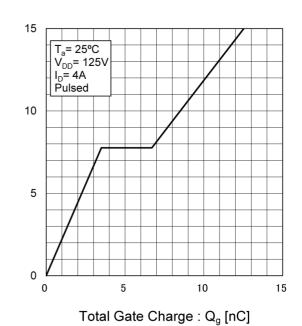


Fig.16 Gate Charge



Gate - Source Voltage : V_{GS} [V]

Fig.17 Source Current vs. Source - Drain Voltage

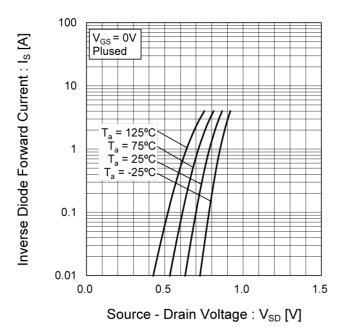
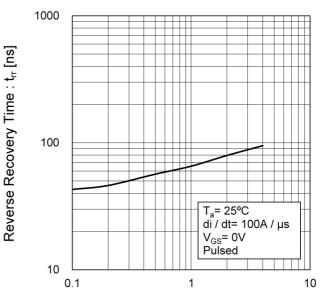


Fig.18 Reverse Recovery Time vs. Source Current



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

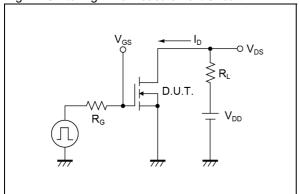


Fig.2-1 Gate Charge Measurement Circuit

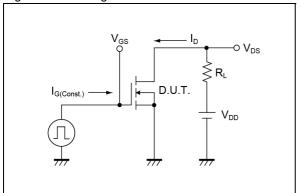


Fig.3-1 Avalanche Measurement Circuit

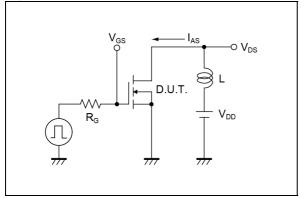


Fig.4-1 trr Measurement Circuit

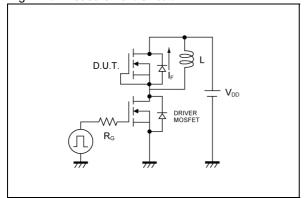


Fig.1-2 Switching Waveforms

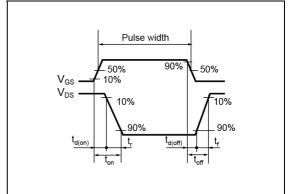


Fig.2-2 Gate Charge Waveform

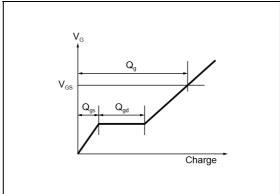


Fig.3-2 Avalanche Waveform

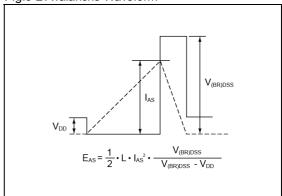
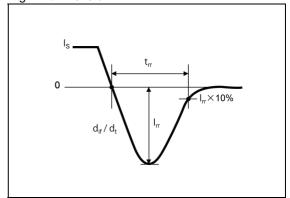
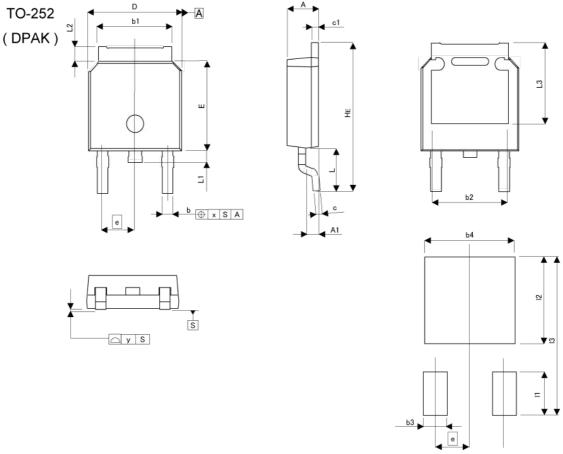


Fig.4-2 trr Waveform



Dimensions



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIME	TERS	INC	HES
DIIVI	MIN	MAX	MIN	MAX
Α	2.10	2.30	0.083	0.091
A1	0.70	1.10	0.028	0.043
b	0.65	0.85	0.026	0.033
b1	5.10	5.40	0.201	0.213
b2	5.	10	0.2	.01
С	0.40	0.60	0.016	0.024
c1	0.40	0.60	0.016	0.024
D	6.40	6.80	0.252	0.268
е	2.	30	0.0	91
E	6.00	6.40	0.236	0.252
HE	9.50	10.50	0.374	0.413
L	2.	90	0.1	14
L1	0.70	0.90	0.028	0.035
L2	0.70	1.30	0.028	0.051
L3	5.	30	0.2	:09
Х	-	0.10	0 - 0	0.004
У	-	0.10	-	0.004

	DIM	MILIME	TERS	INC	HES
	DIM	MIN	MAX	MIN	MAX
	b3	-	1.10	020	0.043
	b4	-	5.40	7. -	0.213
	I1	2 ,	2.90	-	0.114
	12	-	5.50	1-	0.217
ſ	13	2	10.50	92	0.413

Dimension in mm/inches



Notice

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1. If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

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ſ	JÁPAN	USA	EU	CHINA
Ī	CLASSⅢ	CL ACCIII	CLASS II b	СГУССШ
ſ	CLASSIV	CLASSⅢ	CLASSⅢ	CLASSⅢ

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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